TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS IV)

TPC8041

Lithium Ion Battery Applications Portable Equipment Applications Notebook PC Applications

- Small footprint due to small and thin package
- Low drain-source ON-resistance: R_{DS} (ON) = 5.5 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 26 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = 10 \ \mu A \ (max) \ (V_{DS} = 30 \ V)$
- Enhancement mode: V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

	Character	ristics	Symbol	Rating	Unit
	Drain-source voltage		V _{DSS}	30	V
	Drain-gate voltage (R	t _{GS} = 20 kΩ)	V _{DGR}	30	V
	Gate-source voltage		V _{GSS}	±20	V
	Drain current	DC (Note 1)	Ι _D	13	А
		Pulse (Note 1)	I _{DP}	52	A
	Drain power dissipation	on (t = 10 s) (Note 2a)	PD	1.9	W
	Drain power dissipation	on (t = 10 s) (Note 2b)	PD	1.0	W
	Single pulse avalanch	ne energy (Note 3)	E _{AS}	44	mJ
www.Data	ww.DatasAvalahchercurrent			13	А
	Repetitive avalanche (energy Note 2a) (Note 4)	E _{AR}	0.066	mJ
	Channel temperature		T _{ch}	150	°C
	Storage temperature	range	T _{stg}	-55 to 150	°C

Note 1, Note 2, Note 3 and Note 4: See the next page.

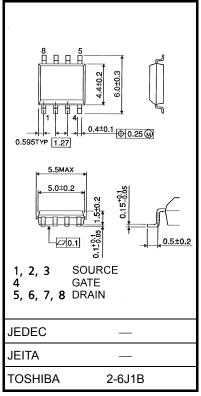
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly

even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

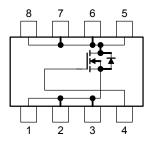
This transistor is an electrostatic-sensitive device. Please handle with caution.





Weight: 0.08 g (typ.)

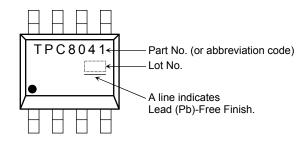
Circuit Configuration

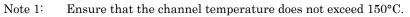


Thermal Characteristics

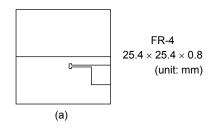
Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	65.8	°C/W	
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	125	°C/W	

Marking (Note 5)

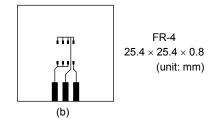




Note 2: (a) Device mounted on a glass-epoxy board (a)



(b) Device mounted on a glass-epoxy board (b)



Note 3: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.2 mH, I_{AR} = 13 A www.DataSheet4U.com

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: • on lower left of the marking indicates Pin 1.



Electrical Characteristics (Ta = 25°C)

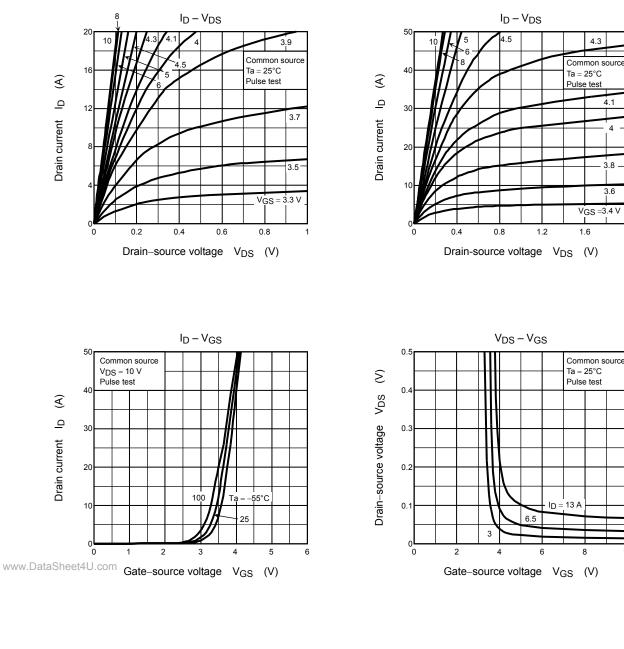
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I _{GSS}	$V_{GS}=\pm 20~V,~V_{DS}=0~V$	_		±100	nA	
Drain cut-OFF current		I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		10	μA	
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30		_	v	
		V (BR) DSX	$I_D = 10$ mA, $V_{GS} = -20$ V	10	_	—	v	
Gate threshold voltage		V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	1.3		2.5	V	
Drain-source ON-resistance		R _{DS (ON)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$	_	9	13.5	mΩ	
			$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$	_	5.5	7	1115.2	
Forward transfer admittance		Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$	13	26	_	S	
Input capacitance		C _{iss}		_	1270	—	pF	
Reverse transfer capacitance		C _{rss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	_	240	_		
Output capacitan	Output capacitance			_	380	—		
Switching time	Rise time	tr	10 V 🗖 lp = 6.5 A	_	11	_		
	Turn-ON time	t _{on}	$V_{GS} \stackrel{10}{}_{0}V \prod \qquad I_{D} = 6.5 \text{ A}$		20	_	- ns	
	Fall time	t _f	R = 2.3 5	_	15	_		
	Turn-OFF time	t _{off}	$V_{DD}\approx 15~V$ Duty \leq 1%, $t_W=10~\mu s$	_	39	_		
Total gate charge (gate-source plus gate-drain)		Qg			27		nC	
Gate-source charge 1		Q _{gs1}	$V_{DD} \approx 24 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$		4.2	_		
Gate-drain ("miller") charge		Q _{gd}			8.2			

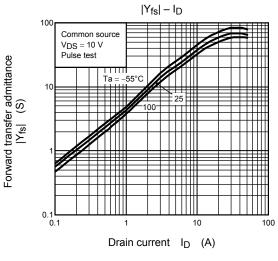
Source-Drain Ratings and Characteristics (Ta = 25°C)

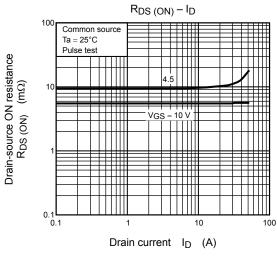
www.Data	Characteristics			Symbol	Test Condition	Min	Тур.	Max	Unit
	neel40.com	Pulse (N	Note 1)	I _{DRP}	—	_	_	52	А
	Forward voltage (diode)			V _{DSF}	$I_{DR} = 13 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.2	V

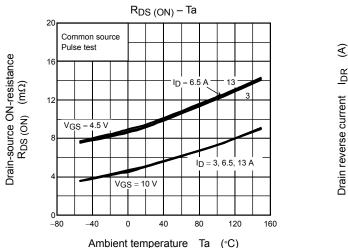
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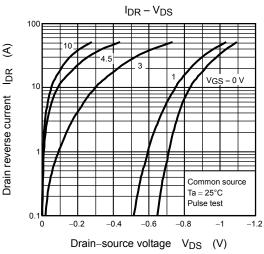
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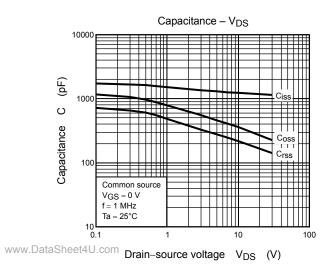


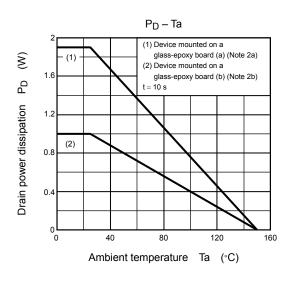


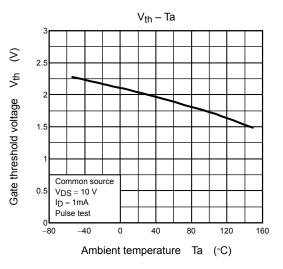


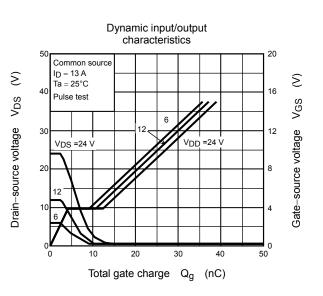


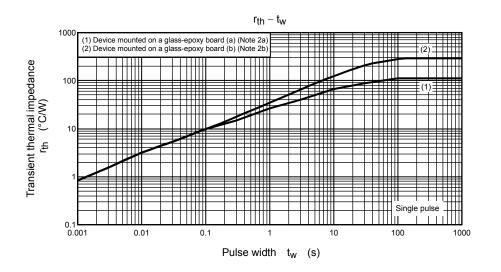


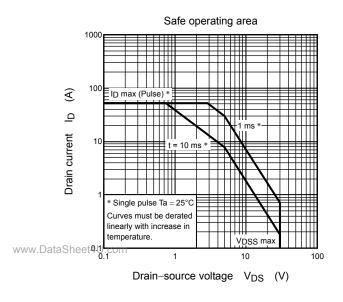












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